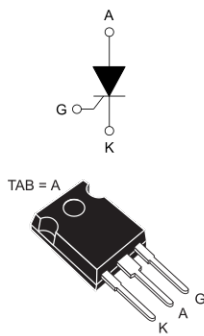



30 A, 1200 V automotive grade SCR Thyristor



TO-247 un-insulated

Features

- AEC-Q101 qualified 
- High junction temperature: $T_j = 150\text{ }^\circ\text{C}$
- AC off state voltage: +/- 1200 V
- Nominal on-state current: 30 A_{RMS}
- High noise immunity: $1000\text{ V}/\mu\text{s}$
- Max. gate triggering current: 50 mA
- ECOPACK2 compliant component

Applications

- Automotive applications: on board and off board battery charger
- Renewable energy inverters
- Solid state relay
- 3-Phase heating or motor soft start control
- UPS (uninterruptible power supply)
- Bypass SSR / hybrid relay
- Inrush current limiter in battery charger
- AC-DC voltage controlled rectifier
- Industrial welding systems

Description

The TN3050H-12WY is an automotive grade SCR Thyristor designed for applications such as automotive on-board chargers, solid state AC relays and stationary battery chargers.

This SCR Thyristor, rated for a 30 A RMS power switching, offers superior performance in peak voltage robustness up to 1400 V and surge current handling up to 300 A sine wave pulse. Its key features allow the design of functions such as a 42 A RMS AC switch (dual back-to-back SCRs) and a 38 A average AC-DC controlled rectifier bridge for inrush current limitation.

Available in through-hole TO-247 package, this power package allows a thermal operation up to 30 A RMS with a higher case temperature of $126\text{ }^\circ\text{C}$.

Product status	
TN3050H-12WY	
Product summary	
$I_{\text{T(RMS)}}$	30 A
$V_{\text{DRM}}/V_{\text{RRM}}$	1200 V
$V_{\text{DSM}}/V_{\text{RSM}}$	1400 V
I_{GT}	50 mA
T_j	$150\text{ }^\circ\text{C}$

1 Characteristics

Table 1. Absolute ratings (limiting values)

Symbol	Parameter		Value	Unit
$I_{T(RMS)}$	RMS on-state current (180 ° conduction angle)		30	A
$I_{T(AV)}$	Average on-state current (180 ° conduction angle)			
$I_{TSM}^{(1)}$	Non repetitive surge peak on-state current, $V_R = 0$ V	$t_p = 8.3$ ms	330	A
		$t_p = 10$ ms		
V_{DRM}/V_{RRM}	Repetitive off-state voltage (50-60 Hz)		1200	V
di/dt	$I_G = 2 \times I_{GT}$, $t_r \leq 100$ ns Critical rate of rise of on-state current	$f = 50$ Hz	200	A/ μ s
I_{GM}	Peak forward gate current	$t_p = 20$ μ s	8	A
$P_{G(AV)}$	Average gate power dissipation		1	W
T_{stg}	Storage junction temperature range		-40 to +150	°C
T_j	Operating junction temperature		-40 to +150	°C

1. ST recommend I^2t value for fusing = 450 A²s for $T_j = 25$ °C and $t_p = 10$ ms

Table 2. Electrical characteristics ($T_j = 25$ °C unless otherwise specified)

Symbol	Test Conditions		Value	Unit
I_{GT}	$V_D = 12$ V, $R_L = 33$ Ω		Min.	10
			Max.	50
V_{GT}	$V_D = 12$ V, $R_L = 33$ Ω		Max.	1.3
V_{GD}	$V_D = 2/3 \times V_{DRM}$, $R_L = 3.3$ k Ω	$T_j = 150$ °C	Min.	0.2
I_H	$I_T = 500$ mA, gate open		Max.	100
I_L	$I_G = 1.2 \times I_{GT}$		Max.	125
t_{gt}	$I_T = 60$ A, $V_D = 2/3 \times V_{DRM}$, $I_G = 100$ mA, $di_G/dt = 0.2$ A/ μ s		Typ.	1
dV/dt	$V_D = 2/3 \times V_{DRM}$, gate open	$T_j = 150$ °C	Min.	1000
t_q	$I_T = 20$ A, $di_T/dt = 10$ A/ μ s, $V_R = 75$ V, $V_D = 2/3 \times V_{DRM}$, $dV_D/dt = 20$ V/ μ s, $t_p = 100$ μ s	$T_j = 150$ °C	Typ.	150
V_{TM}	$I_{TM} = 60$ A, $t_p = 380$ μ s		Max.	1.65
V_{TO}	Threshold voltage		$T_j = 150$ °C	Max.
R_D	Dynamic resistance		$T_j = 150$ °C	Max.
I_{DRM}/I_{RRM}	$V_D = V_{DRM}$, $V_R = V_{RRM}$	$T_j = 25$ °C	Max.	5
		$T_j = 125$ °C	Max.	3
		$T_j = 150$ °C	Max.	5
I_{DSM}/I_{RSM}	$V_D = V_{DSM}$, $V_R = V_{RSM}$		$T_j = 25$ °C	Max.

Table 3. Thermal parameters

Symbol	Parameter	Value	Unit
$R_{th(j-c)}$	Junction to case (DC, max.)	0.8	°C/W
$R_{th(j-a)}$	Junction to ambient (typ.)	50	

1.1 Characteristics curves

Figure 1. Maximum average power dissipation versus average on-state current

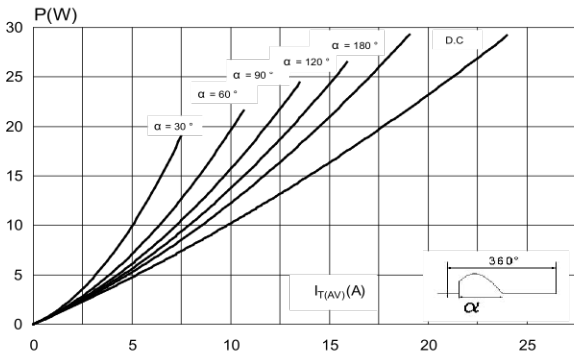


Figure 2. Average and DC on-state current versus case temperature

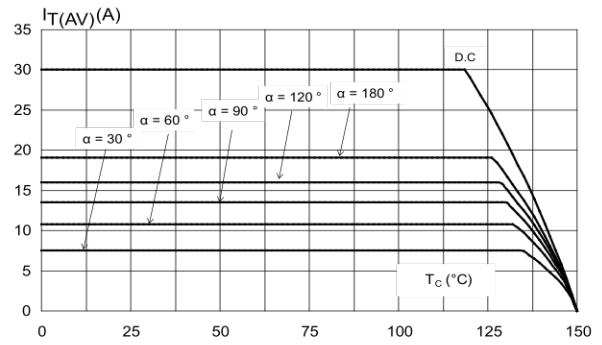


Figure 3. On-state characteristics (maximum values)

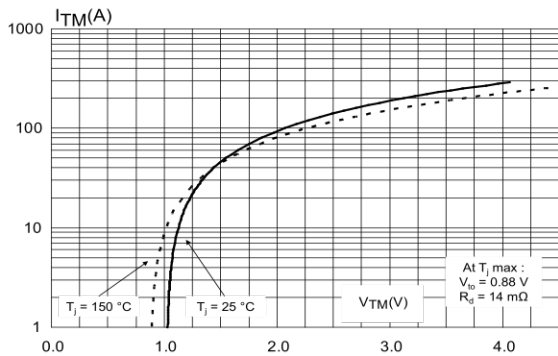


Figure 4. Average and D.C. on-state current versus ambient temperature

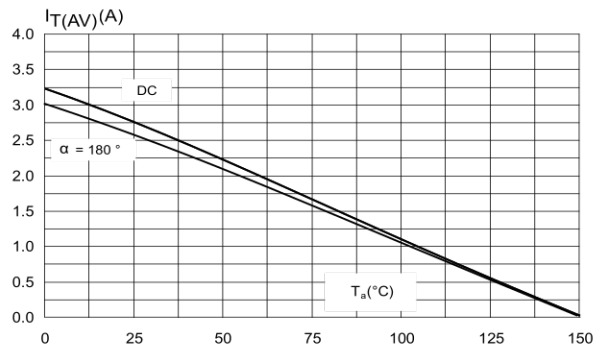


Figure 5. Relative variation of thermal impedance junction to case and junction to ambient versus pulse duration

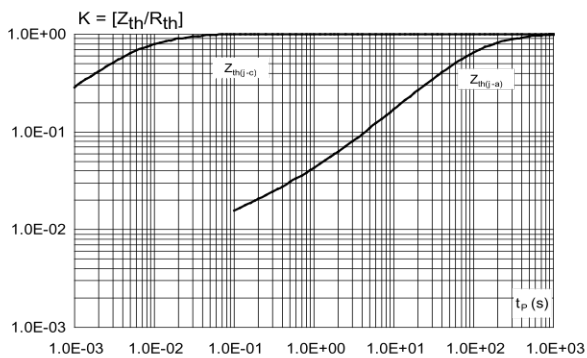


Figure 6. Surge peak on-state current versus number of cycles

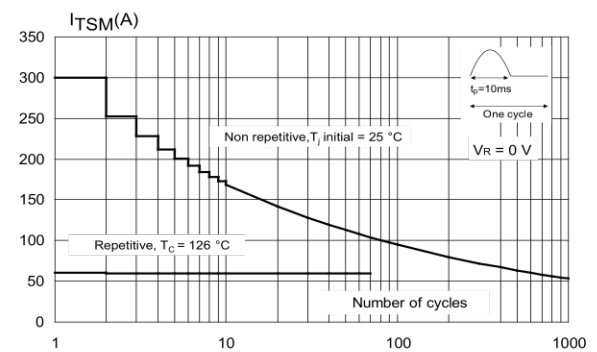


Figure 7. Non repetitive surge peak on-state current for a sinusoidal pulse ($t_p < 10$ ms)

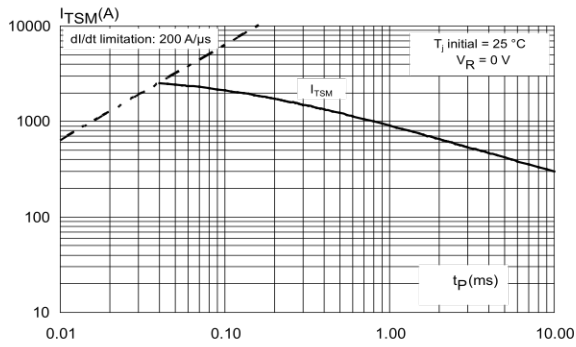


Figure 8. Relative variation of holding and latching current versus junction temperature (typical values)

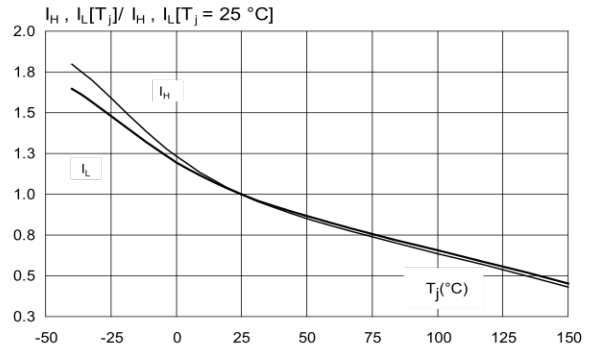


Figure 9. Relative variation of gate triggering current and voltage versus junction temperature

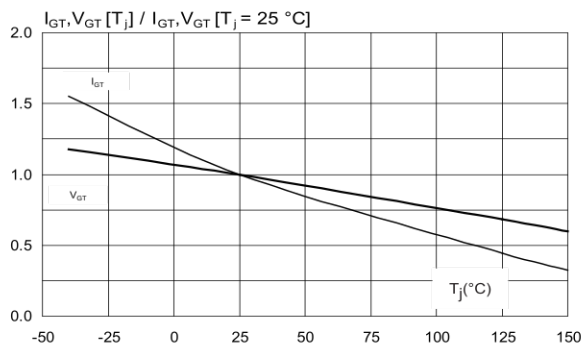


Figure 10. Relative variation of the static dV/dt immunity versus junction temperature (typical values)

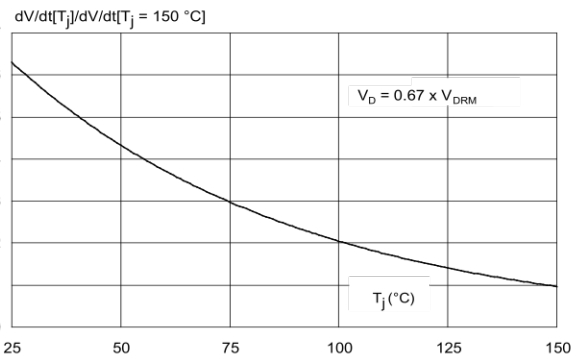
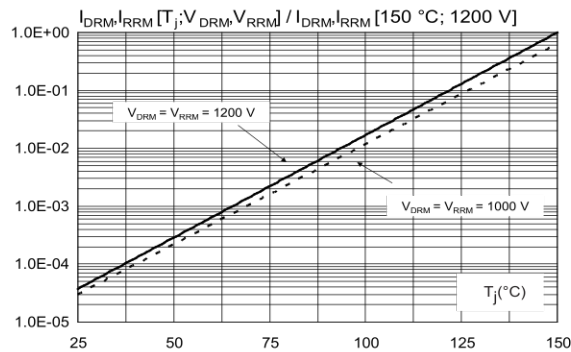


Figure 11. Relative variation of leakage current versus junction temperature for different values of blocking voltage



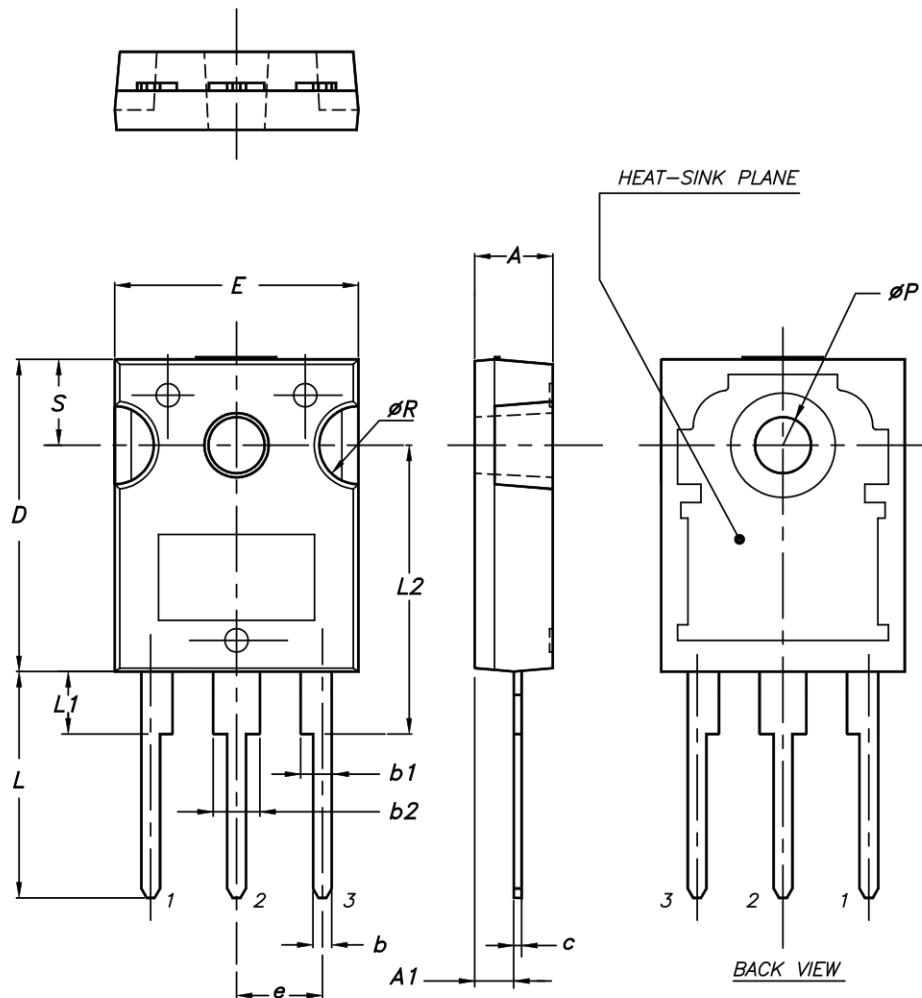
2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of **ECOPACK** packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

2.1 TO-247 package information

- Epoxy meets UL 94,V0
- Recommended torque value: 0.8 N·m
- Maximum torque value: 1 N·m

Figure 12. TO-247 package outline



0075325_9

Table 4. TO-247 package mechanical data

Dim.	Dimensions					
	Millimeters			Inches ⁽¹⁾		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.85		5.15	0.1909		0.2028
A1	2.20		2.60	0.0866		0.1024
b	1.0		1.40	0.0394		0.0551
b1	2.0		2.40	0.0787		0.0945
b2	3.0		3.40	0.1181		0.1339
c	0.40		0.80	0.0157		0.0315
D ⁽²⁾	19.85		20.15	0.7815		0.7933
E	15.45		15.75	0.6083		0.6201
e	5.30	5.45	5.60	0.2087	0.2146	0.2205
L	14.20		14.80	0.5591		0.5827
L1	3.70		4.30	0.1457		0.1693
L2		18.50			0.7283	
ØP ⁽³⁾	3.55		3.65	0.1398		0.1437
ØR	4.50		5.50	0.1772		0.2165
S	5.30	5.50	5.70	0.2087	0.2165	0.2244

1. Inch dimensions given only for reference
2. Dimension D plus gate protrusion does not exceed 20.5 mm
3. Resin thickness around the mounting hole is not less than 0.9 mm

3 Ordering information

Table 5. Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
TN3050H-12WY	TN3050H12Y	TO-247	4.4 g	50	Tube

Revision history

Table 6. Document revision history

Date	Revision	Changes
16-Sep-2016	1	Initial release.
03-Oct-2016	2	Updated Table 3. Thermal parameters.
15-Jan-2019	3	Updated Table 5. Ordering information.
05-Aug-2019	4	Updated Section Description and Table 1. Absolute ratings (limiting values).
31-Mar-2020	5	Updated Figure 6 and Figure 7.

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